

Find the right product for your application



SUBSTRATE

Metal

LOCTITE® 567™
LOCTITE® 577™
LOCTITE® 561™
LOCTITE® 569™

Plastic

LOCTITE® SI 5331™
LOCTITE® 55™



Metal THREAD SEALANTS



567™
General Purpose



Substrate: Metal



Thread Type: Tapered, NPT and Straight



Form: Paste

Viscosity: 540,000 Thixotropic
Temperature Resistance: 250°C



577™
General Purpose



Substrate: Metal



Thread Type: Coarse



Form: Paste

Viscosity: 25,000 mPa·s
Temperature Resistance: 180°C



561™
No-drip, No-mess



Substrate: Metal



Thread Type: Tapered and Straight



Form: Semi-solid

Viscosity: Semi-solid
Temperature Resistance: 150°C



569™
Metal Pipes and Fittings



Substrate: Metal



Thread Type: Fine



Form: Liquid

Viscosity: Low
Temperature Resistance: 150°C

Plastic THREAD SEALANTS



SI 5331™
General Purpose



Substrate: Plastic, Metal



Thread Type: Coarse



Form: Paste

Viscosity: 50,000 mPa·s
Temperature Resistance: 150°C



55™
Sealing Cord



Substrate: Plastic, Metal



Thread Type: Coarse



Form: Cord

Viscosity: Cord
Temperature Resistance: 150°C